	Туре	L #	Hits	Search Text	DBs	Time Stamp
1	BRS	L1	828	(stress or flex\$4 or strain or bend\$4 or bent or pressure) near4 releas\$4 same slit\$3	ווכטאיד	2004/09/18 18:33
2	BRS	L2	1055	stress near4 slit\$4	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/09/18 18:33
3	BRS	L6	59622		USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/09/18 18:35
4	BRS	L7	52918	(flex\$6 near2 (substrate\$3 or wafer\$3 or board\$3))	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/09/18 18:36
5	BRS	L10	335035	slit or slits		2004/09/18 18:36

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	Туре	L #	Hits	Search Text	DBs	Time Stamp
6	BRS	L11	140546	(reduc\$6 or less\$6 or avoid\$4) near4 (warp\$6 or bent or bend\$4 or stress)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/09/18 18:36
7	BRS	L12	1091	(slit or slits) same ((reduc\$6 or less\$6 or avoid\$4) near4 (warp\$6 or bent or bend\$4 or stress))	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/09/18 18:36
8	BRS	L3	45	(stress near2 releas\$6) near4 slit\$2	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/09/18 18:36
9	BRS	L4	17	(stress near4 slit\$4) and (tape near2 carrier)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/09/18
10	BRS	L 5	1307	(stress or flex\$4 or strain or bend\$4 or bent or pressure) near4 releas\$4 same slit\$3	JPO:	2004/09/18 18:37

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	Туре	L #	Hits	Search Text	DBs	Time Stamp
11	BRS	L8	28	((stress or flex\$4 or strain or bend\$4 or bent or pressure) near4 releas\$4 same slit\$3) and ((flex\$6 near2 (substrate\$3 or wafer\$3 or board\$3)))	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/09/18 18:37
12	BRS	L 9	6	"stress releasing slit" or (stress-releasing adj slit)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/09/18 18:37
13	BRS	L13	20	((slit or slits) near8 ((reduc\$6 or less\$6 or avoid\$4) near4 (warp\$6 or bent or bend\$4 or stress))) and (LCD or "liquid crystal")	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/09/18 18:37
14	BRS	L14	392	(slit or slits) near8 ((reduc\$6 or less\$6 or avoid\$4) near4 (warp\$6 or bent or bend\$4 or stress))	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/09/18 18:37
15	BRS	L15	180	((slit or slits) near8 ((reduc\$6 or less\$6 or avoid\$4) near4 (warp\$6 or bent or bend\$4 or stress))) not (((slit or slits) near8 ((reduc\$6 or less\$6 or avoid\$4) near4 (warp\$6 or bent or bend\$4 or stress))) and (LCD or "liquid crystal"))	USPAT	2004/09/18 18:37

	Туре	L #	Hits	Search Text	DBs	Time Stamp
16	BRS	L16	372	<pre>not (((slit or slits) near8 ((reduc\$6 or less\$6 or avoid\$4) near4 (warp\$6 or</pre>	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/09/18 18:37
17	BRS	L17	13	slit near2 releasing near2 stress	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/09/18 18:56
18	BRS	L18	205332	tanaka.in.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/09/18 18:56
19	BRS	L19	3340	18 and slit	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/09/18
20	BRS	L20	13	19 and "flexible substrate"	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/09/18 19:03

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	Туре	L #	Hits	Search Text	DBs	Time St
21	IS&R	L22	690	(257/669).CCLS.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/09, 19:04
22	BRS	L26	64	23 and slit	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/09, 19:17
23	BRS	L27	36	26 and stress	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/09 19:06
24	BRS	L28	18	25 and slit	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/09 19:17
25	IS&R	L29	1142	(257/668).CCLS.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/09

	Туре	L #	Hits	Search Text	DBs	Time Stamp
26	IS&R	L30	897	(257/E23.065).CCLS.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/09/18 20:09
27	IS&R	L31	315	(257/E23.177).CCLS.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/09/18 20:40